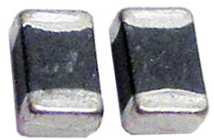


SMD Multilayer Chip Bead

ACML-0201



RoHS
Compliant



0.6 x 0.3 x 0.3 mm

FEATURES:

- Internal silver printed layers and magnetically shielded to minimize crosstalk
- Substantial EMI suppression over a wide frequency range
- Excellent solderability and heat resistance

APPLICATIONS:

- Noise suppression for computers and peripheral devices, DVD cameras, LCD TVs, communication equipments, OA equipments, etc.
- Reduces noise in ultra high speed circuits as well

STANDARD SPECIFICATIONS:

Operating Temperature: -55°C ~ +125°C

Storage Temperature: -10°C to +40°C, 70% RH max

Part No.	Z(Ω) ± 25%	Z Test Freq.	DCR (Ω)	Ir (mA)
		(MHz)	(max)	(max)
ACML-0201-600	60	100	0.40	200
ACML-0201-800	80	100	0.60	200
ACML-0201-121	120	100	0.80	200
ACML-0201-241	240	100	1.00	200
ACML-0201-471	470	100	1.40	200
ACML-0201-601	600	100	1.70	200

Test Conditions and equipments

Z: High Accuracy RF Impedance/Material Analyzer -E4991A, 100MHz, -20dBm or 50mV

DCR: High Accuracy Milliohmmeter –HP4338B

Ir: Electric Power Supply, Electric Current Meter, Thermometer. $\Delta T \leq 20^\circ C$

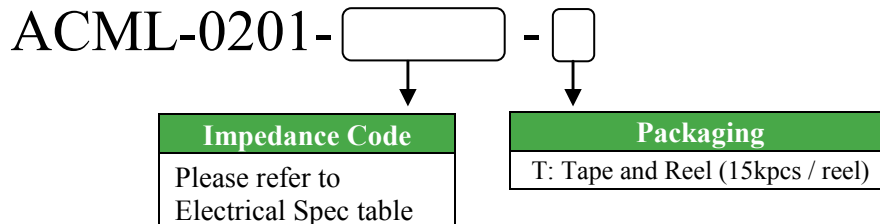
Unless otherwise specified, the standard atmospheric conditions for measurement/test as:

- Ambient Temperature: 20±15°C
- Relative Humidity: 65%±20%
- Air Pressure: 86 KPa to 106 KPa

Visual Examination

- Inspection Equipment: 20X magnifier

OPTIONS AND PART IDENTIFICATION:

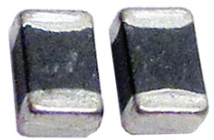


SMD Multilayer Chip Bead

ACML-0201



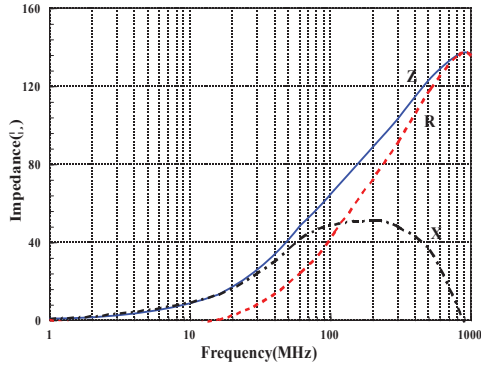
RoHS
Compliant



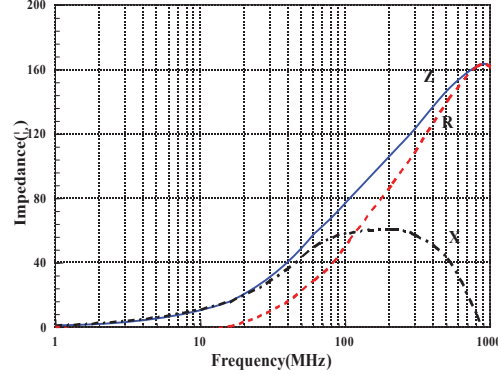
0.6 x 0.3 x 0.3 mm

FREQUENCY RESPONSE

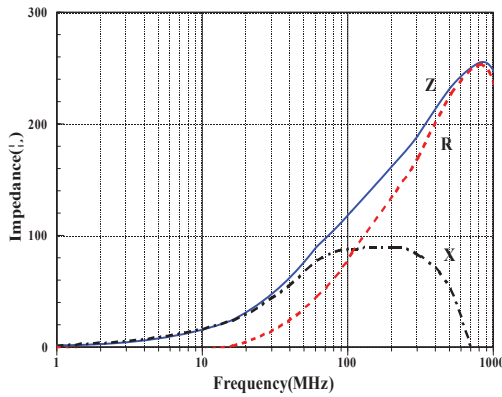
ACML-0201-600



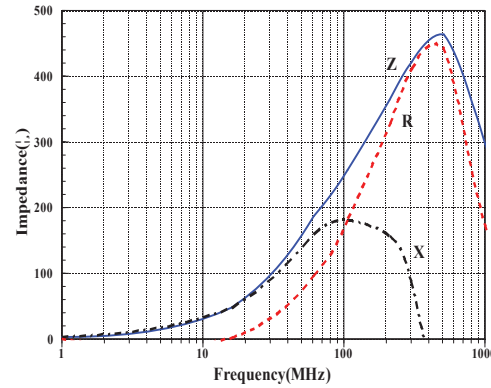
ACML-0201-800



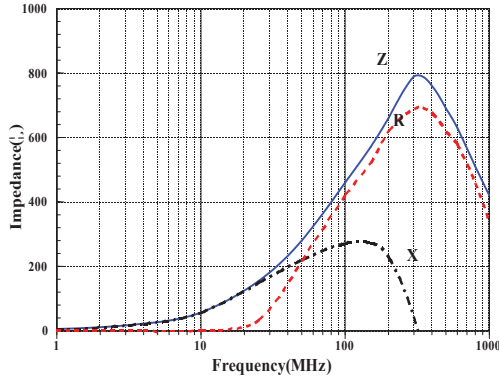
ACML-0201-121



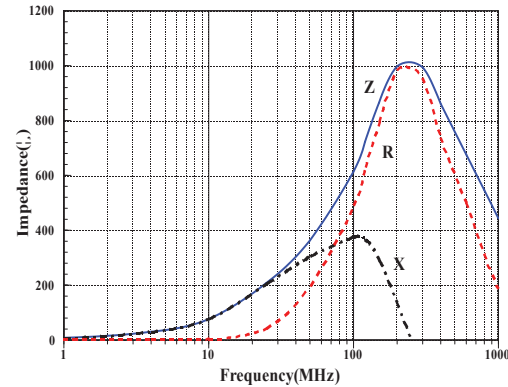
ACML-0201-241



ACML-0201-471



ACML-0201-601



SMD Multilayer Chip Bead

ACML-0201



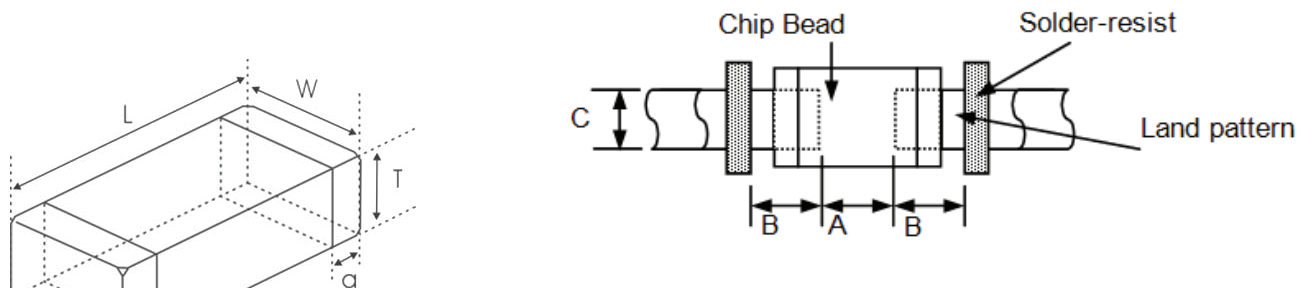
RoHS
Compliant



0.6 x 0.3 x 0.3 mm

OUTLINE DRAWING:

Recommended Land Pattern

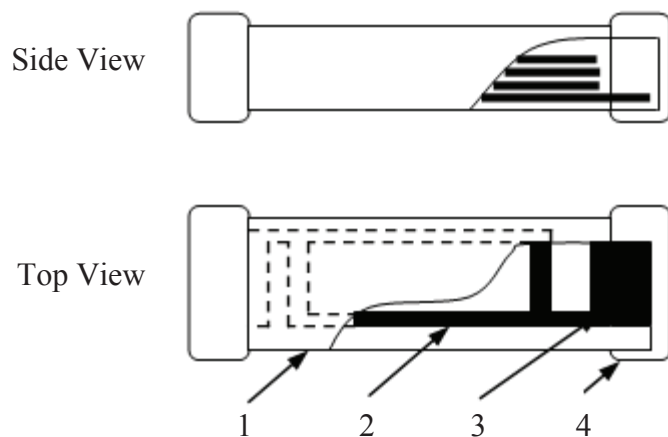


A	B	C
0.2~0.3	0.2~0.3	0.3~0.35

Series	L	W	T	a
ACML-0201	0.6±0.05 [0.024±0.002]	0.3±0.05 [0.012±0.002]	0.3±0.05 [0.012±0.002]	0.15±0.05 [0.006±0.002]

Dimension: mm [inch]

Materials



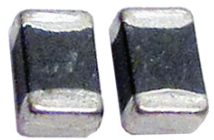
	Part Name	Material
1	Base Material	Ferrite
2	Internal Conductor	Ag
3	Pull out Electrode	Ag
4	Terminal Electrode	Ag (Inner layer) Ni-Sn (Outer layer)

SMD Multilayer Chip Bead

ACML-0201

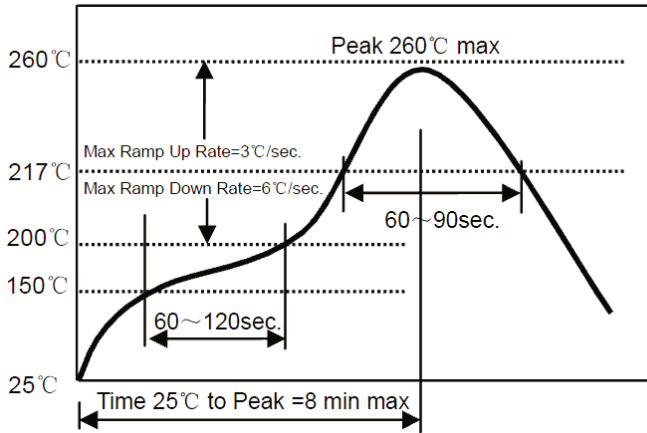


**RoHS
Compliant**



0.6 x 0.3 x 0.3 mm

REFLOW PROFILE:

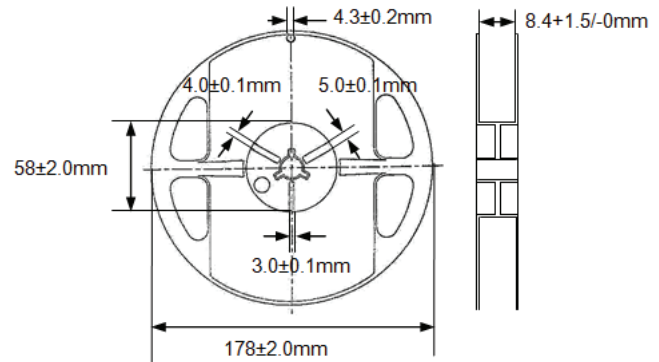
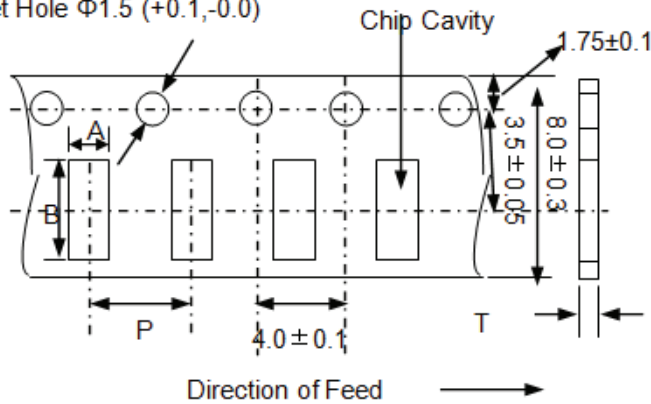


Preheat Condition	150 to 200 °C; 60 to 120 sec.
Albwd time above 217 °C	60 to 90 sec.
Max temperature	260 °C
Max time at max temperature	10 sec.
Solder paste	Sn/3.0Ag/0.5Cu
Allowed Reflow time	2x max.

TAPE & REEL:

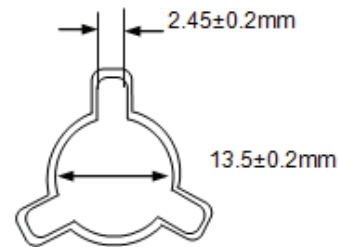
T: 15,000pcs / reel

Sprocket Hole $\Phi 1.5 (+0.1, -0.0)$



Direction of Feed →

A	B	P	t(max)
0.40±0.1	0.70±0.1	2.0±0.1	0.55



Dimension: mm

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